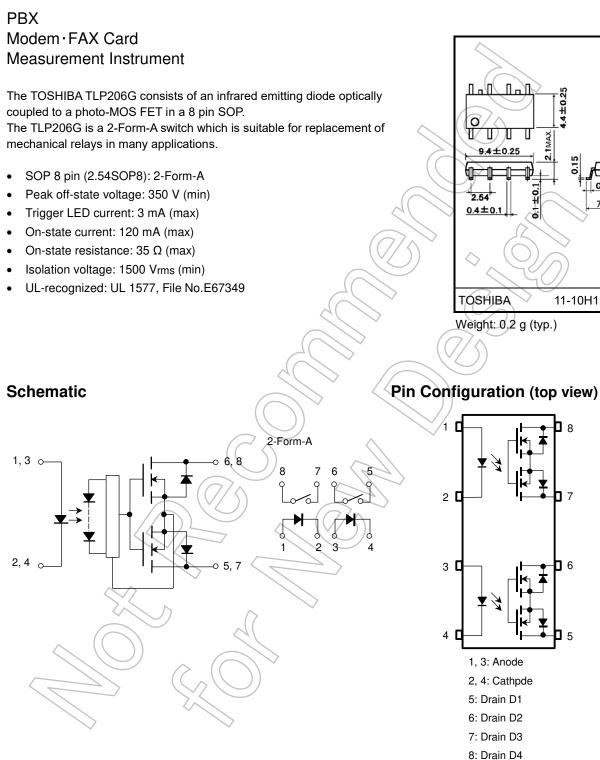
Unit: mm

 0.6 ± 0.3

7.0±0.4

TOSHIBA Photocoupler IRED & Photo-MOS FET

TLP206G



Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit		
	Forward current		١ _F	50	mA	
ED	Forward current derating (Ta ≥ 25°C)		ΔI _F / °C	-0.5	mA / °C	
	Pulse forward current (100µs pulse, 100pps)		IFP	1	A	
	Reverse voltage		VR	5	V	
	Diode power dissipation		PD	50	mW	JY
	Diode power dissipation derating (Ta \ge 25°C)		ΔP _D /°C	-0.5	mW/°C	
	Junction temperature		Tj	125	(°C)	
	Off-state output terminal voltage		VOFF	350	V	
	On-state current	Both channel	I _{ON}	100	mA	
		One channel		120		
etector	On-state RMS current derating(Ta ≥ 25°C)	Both channel	AL (20	-1.0	mA / °C	$\mathcal{A}(\mathcal{D})$
Dete		One channel	Δl _{ON} / °C	-1.2		5
	Output power dissipation		Po	454	mW	YM
	Output power dissipation derating (Ta \geq 25°C)		ΔP _O /°C	-4.54	mW / °C	
	Junction temperature		ti	125	00)	
Stor	age temperature range	Tstg	-55 to 125	°C		
Ope	rating temperature range	Topr	-40 to 85	ĵ∾ C		
Lea	d soldering temperature (Tsol	260	_•¢		
Isola	ation voltage (AC, 60 s, R	.H.≤ 60 %) (Note 1)	BVs	1500	V _{rms}	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pins1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	_	_	280	V
Forward current	lF	5	7.5	25	mA
On-state current	I _{ON}	_	_	100	mA
Operating temperature	T _{opr}	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/	30	_	pF
Detector	Off-state current	IOFF	V _{OFF} = 350 V			1	μΑ
Dete	Capacitance	COFF	V = 0 V, f = 1MHz		40		pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	IFT	I _{ON} = 120 mA	- ~	26	3	mA
On-state resistance	R _{ON}	I _{ON} = 120 mA, I _F = 5 mA	70	22	35	Ω

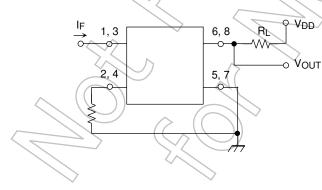
Isolation Characteristics (Ta = 25°C)

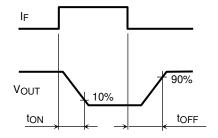
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	VS = 0 V, f = 1 MHz	(7/) -	0.8	_	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	1500	—		V _{rms}

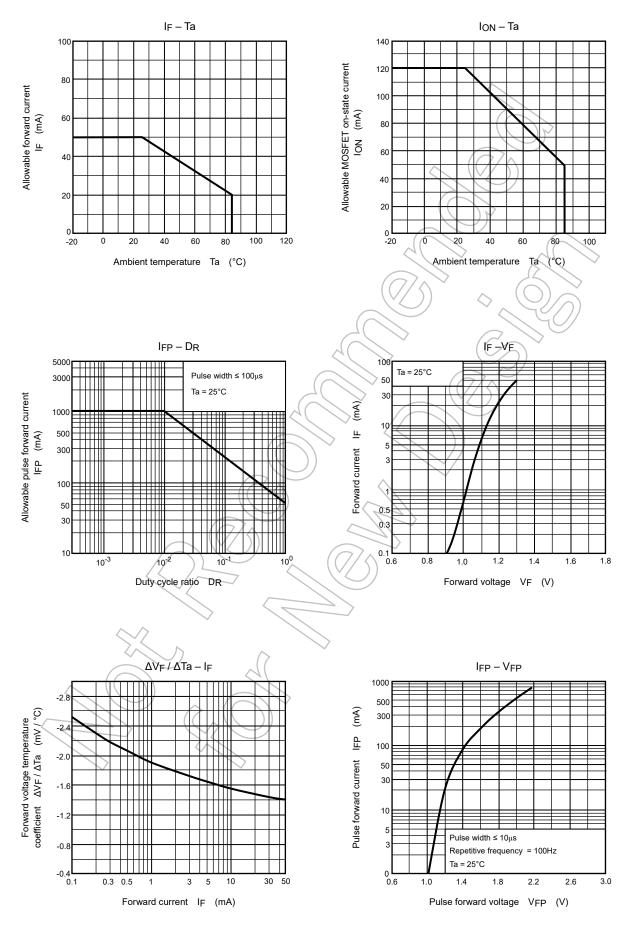
Switching Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	(ton	$R_L = 200 \Omega$ (Note 2)	_	0.3	1	
Turn-off time	toff	$V_{DD} = 20 V, I_F = 5 mA$	_	0.1	1	ms

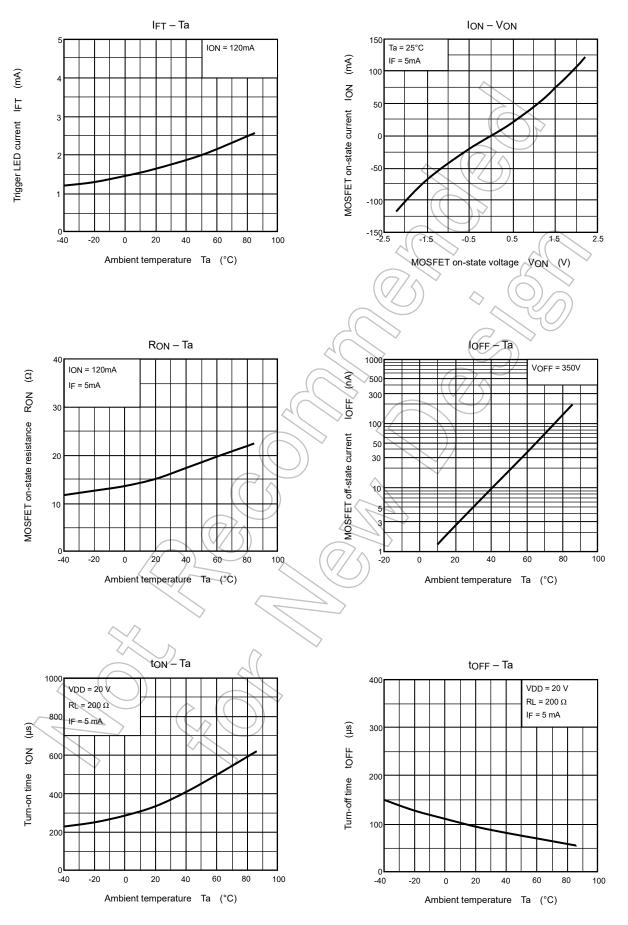
Note 2: Switching time test circuit

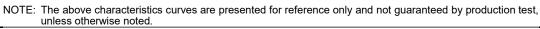






NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





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